DATA SHEET

Solid State Relay OCMOS FET

PS7241E-1B

4-PIN SOP 400 V BREAK DOWN VOLTAGE NORMALLY CLOSE TYPE 1-ch Optical Coupled MOS FET

-NEPOC Series-

DESCRIPTION

NEC

The PS7241E-1B is an optically coupled element that combines a GaAs infrared LED on the input side with a normally close MOS FET on the output side to realize an excellent cost performance.

The small, thin package and high sensitivity of this element makes it ideal for battery-driven mobile devices, and its small offset voltage at power-on and good linearity also make it suitable for controlling micro analog signals.

FEATURES

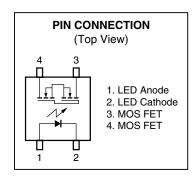
- Small and thin package (4-pin SOP, Height = 2.1 mm)
- 1 channel type (1 b output)
- Low LED operating current (IF = 3 mA)
- Designed for AC/DC switching line changer
- · Low offset voltage
- Ordering number of taping product: PS7241E-1B-E3, E4, F3, F4
- · Pb-Free product
- Safety standards

<R>

- UL approved: File No. E72422
- BSI approved: File No. 8241/8242

APPLICATIONS

- Laptop PC, PDA
- Modem card
- Telephone, FAX
- Measurement equipment



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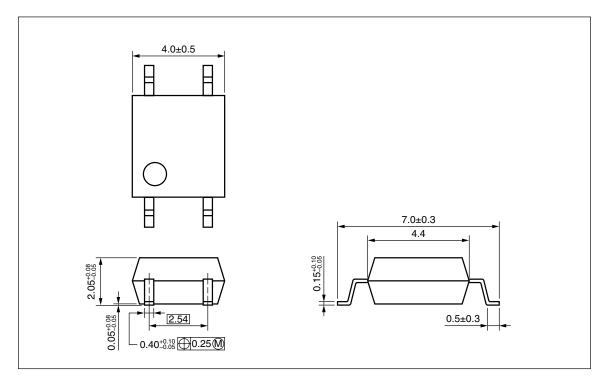
Document No. PN10552EJ03V0DS (3rd edition) Date Published June 2006 NS CP(K) Printed in Japan

The mark <R> shows major revised points.

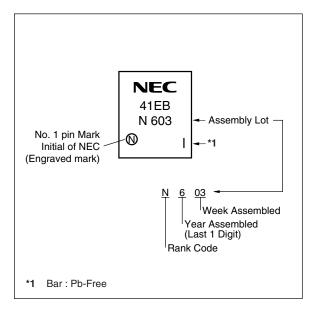
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The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

PACKAGE DIMENSIONS (UNIT: mm)



MARKING EXAMPLE



<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{⁺1}
PS7241E-1B	PS7241E-1B-A	Pb-Free	Magazine case 100 pcs	Standard products	PS7241E-1B
PS7241E-1B-E3	PS7241E-1B-E3-A		Embossed Tape 900 pcs/reel	(UL, BSI approved)	
PS7241E-1B-E4	PS7241E-1B-E4-A				
PS7241E-1B-F3	PS7241E-1B-F3-A		Embossed Tape 3 500 pcs/reel		
PS7241E-1B-F4	PS7241E-1B-F4-A				

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	lf	50	mA
	Reverse Voltage	VR	5.0	V
	Power Dissipation	Po	50	mW
	Peak Forward Current ⁺¹	IFP	1	А
MOS FET	Break Down Voltage	VL	400	V
	Continuous Load Current	lı.	120	mA
	Pulse Load Current ^{*2} (AC/DC Connection)	Ilp	240	mA
	Power Dissipation	Po	300	mW
Isolation Voltage ^{*3}		BV	1 500	Vr.m.s.
Total Power Dissipation		Рт	350	mW
Operating Ambient Temperature		TA	-40 to +85	°C
Storage Temperature		Tstg	-40 to +100	°C

*1 PW = 100 μs, Duty Cycle = 1%

*2 PW = 100 ms, 1 shot

*3 AC voltage for 1 minute at $T_A = 25^{\circ}$ C, RH = 60% between input and output Pins 1-2 shorted together, 3-4 shorted together.

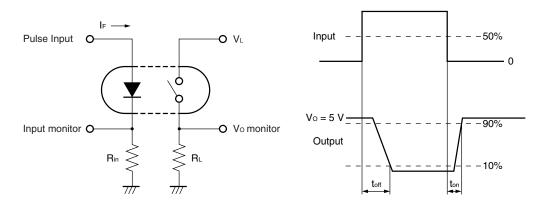
RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lf	3	10	20	mA
LED Off Voltage	VF	0		0.5	V

ELECTRICAL CHARACTERISTICS (TA = 25°C)

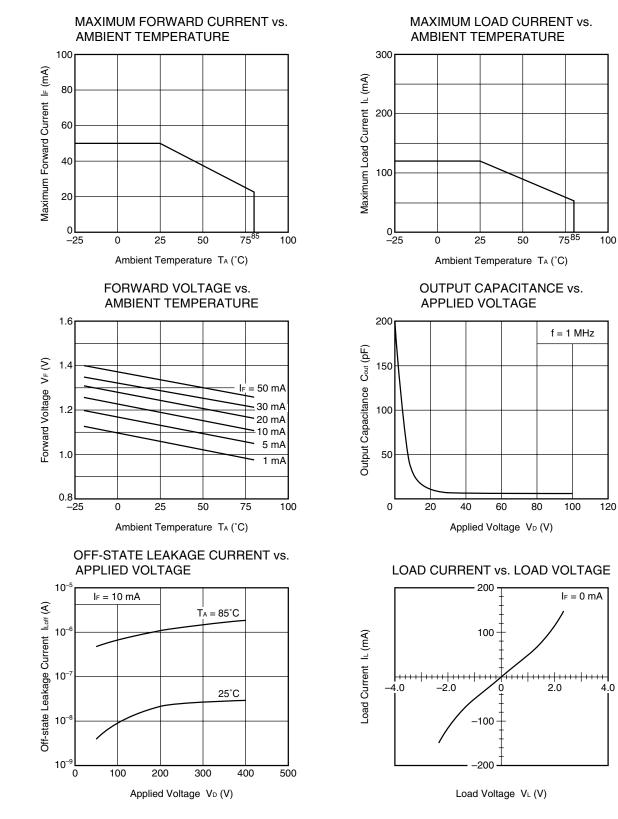
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	IR	V _R = 5 V			5.0	μA
MOS FET	Off-state Leakage Current	Loff	IF = 10 mA, VD = 400 V		0.03	1.0	μA
	Output Capacitance	Cout	I⊧ = 10 mA, V₀ = 0 V, f = 1 MHz		206		pF
Coupled	LED Off-state Current	Foff	I∟ = 120 mA			3.0	mA
	On-state Resistance	Ron1	I⊧ = 0 mA, I∟ = 10 mA		22	35	Ω
		Ron2	I_{F} = 0 mA, I_{L} = 120 mA, $t \leq$ 10 ms		17	24	
	Turn-on Time ^{1,2}	ton	$I_{\text{F}} = 10 \text{ mA}, \text{ V}_{\text{O}} = 5 \text{ V}, \text{ R}_{\text{L}} = 500 \ \Omega,$		0.07	0.2	ms
	Turn-off Time ^{*1, 2}	toff	PW ≥ 10 ms		1.0	3.0	
	Isolation Resistance	Rŀo	VI-O = 1.0 kVDC	10 [°]			Ω
	Isolation Capacitance	CI-0	V = 0 V, f = 1 MHz		0.5		pF

*1 Test Circuit for Switching Time



<R> *2 The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms. Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

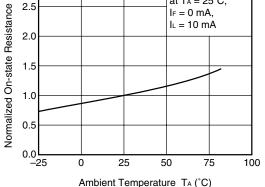
<R> TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)



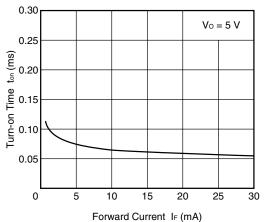
Remark The graphs indicate nominal characteristics.

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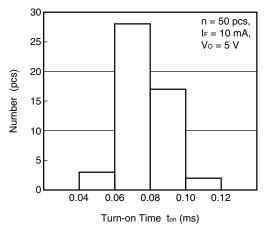
NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE $\frac{5}{2}$ 2.53.0 $at T_A = 25^{\circ}C,$ b = 0 mA



TURN-ON TIME vs. FORWARD CURRENT

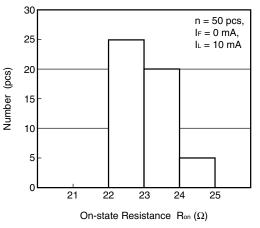


TURN-ON TIME DISTRIBUTION

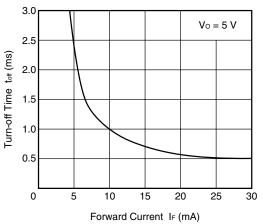


Remark The graphs indicate nominal characteristics.

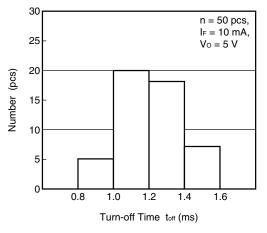
ON-STATE RESISTANCE DISTRIBUTION

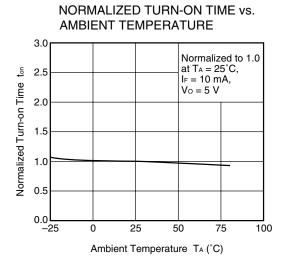


TURN-OFF TIME vs. FORWARD CURRENT

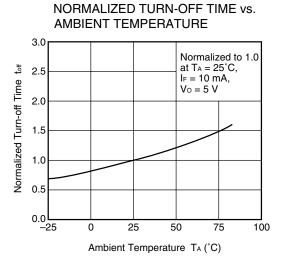


TURN-OFF TIME DISTRIBUTION

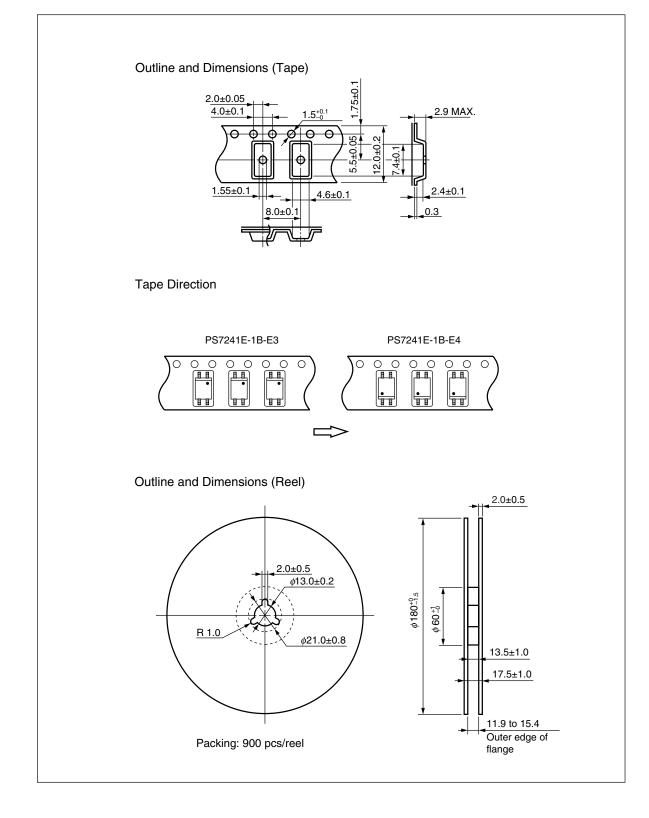




Remark The graphs indicate nominal characteristics.

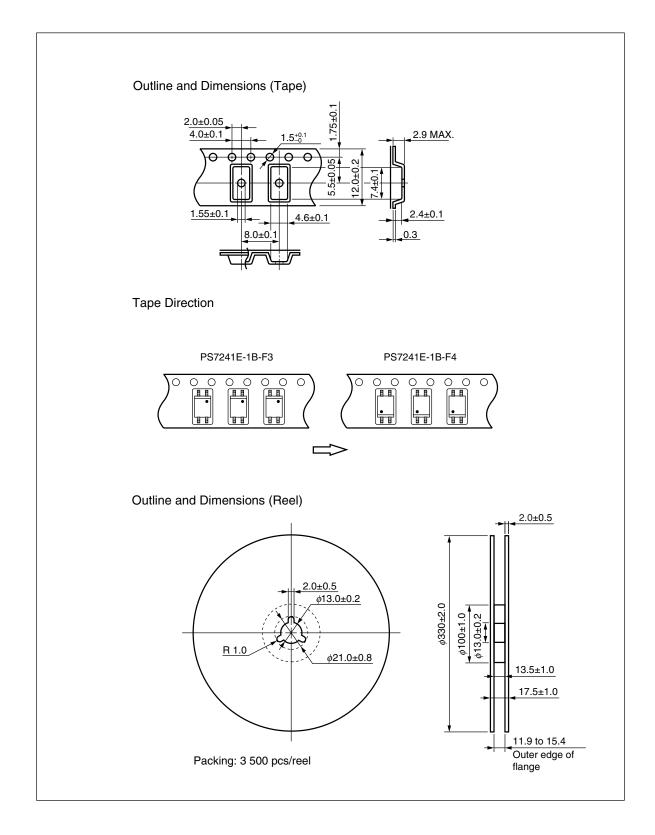


TAPING SPECIFICATIONS (in millimeters)



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RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

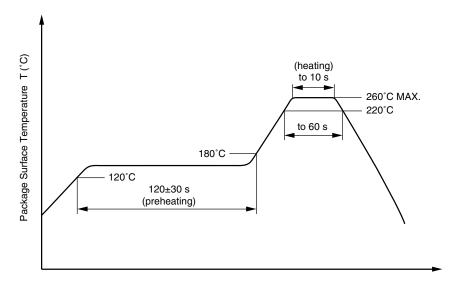
- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a

260°C or below (package surface temperature)

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

 Temperature 	260°C or below (molten solder temperature)
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- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times
 One
- Flux

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

<R> (3) Soldering by soldering iron

 Peak temperature (lead part temperature) 	350°C or below
 Time (each pins) 	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

<R> USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or in any way allow it to enter the mouth.

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